

A

A

B

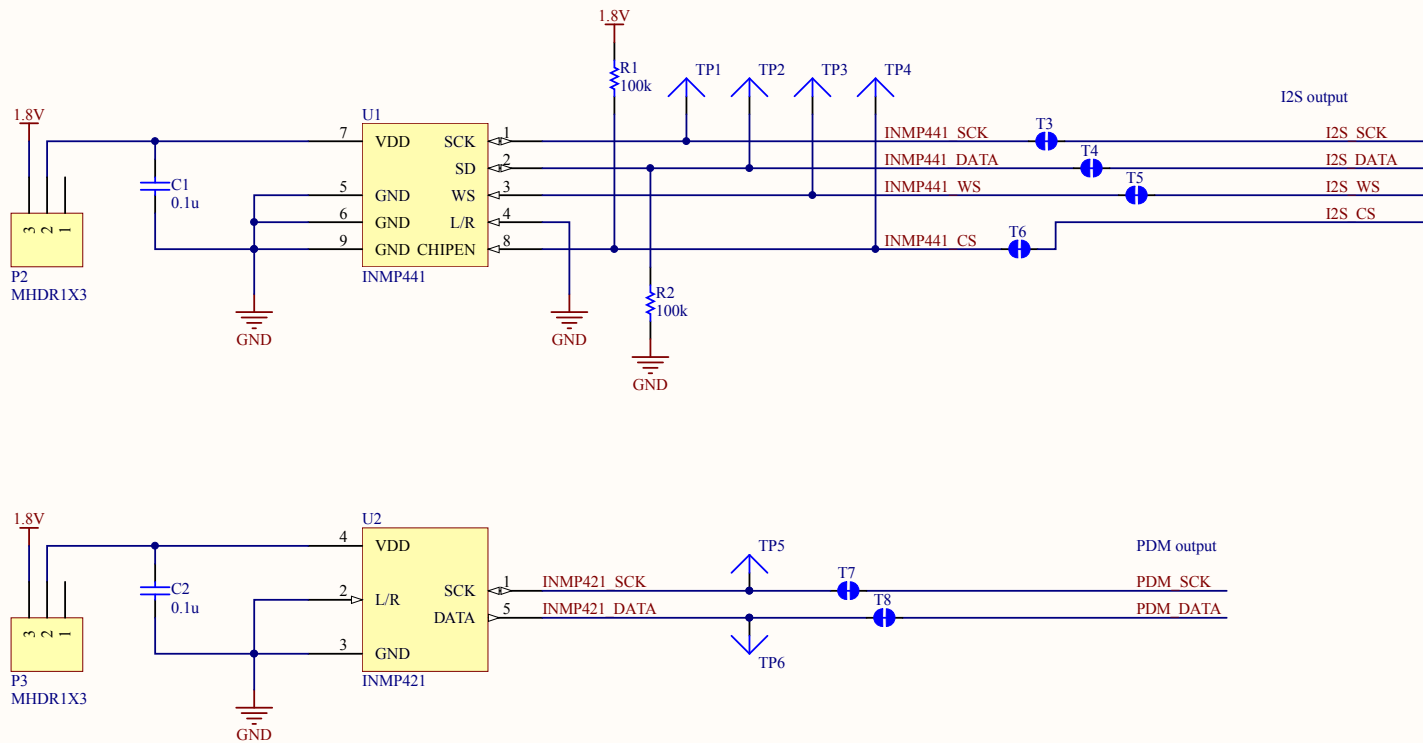
B

C

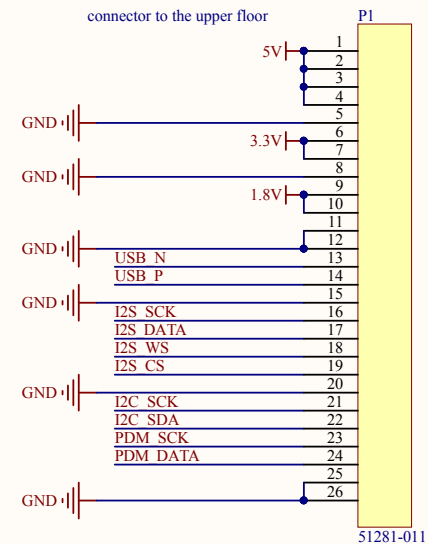
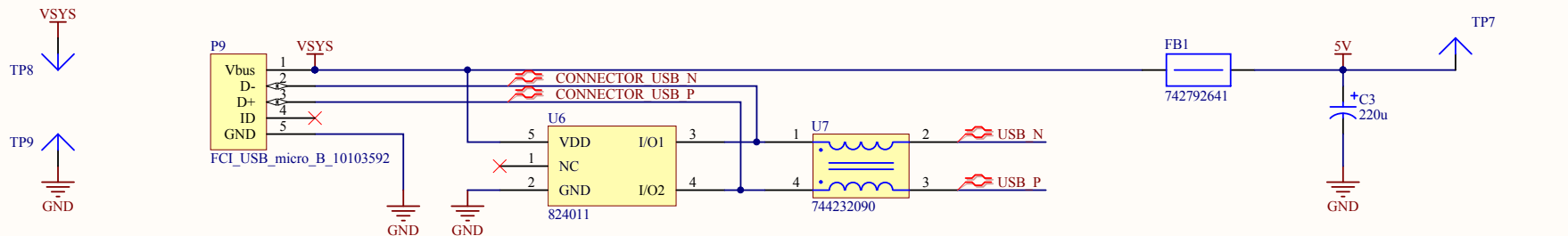
C

D

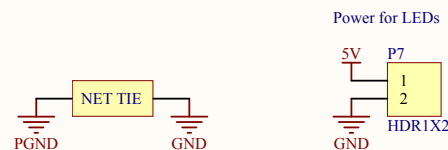
D



Hello		
TITLE Microphone		REV 1
DATE 5/16/2014	DRAWN BY D. Fusi	SHEET 1 OF 3



H1	H2	H3	H4
Hole	Hole	Hole	Hole



# Hello

TITLE Power management		REV 1
DATE 5/16/2014	DRAWN BY D. Fusi	SHEET 2 OF 3

A

B

C

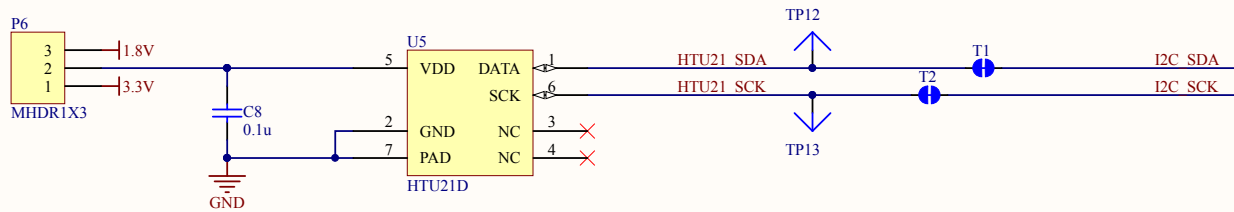
D

A

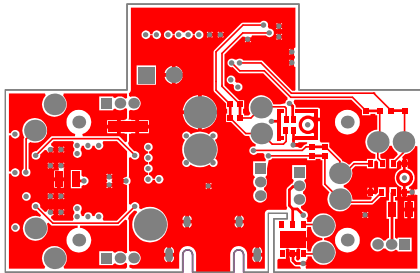
B

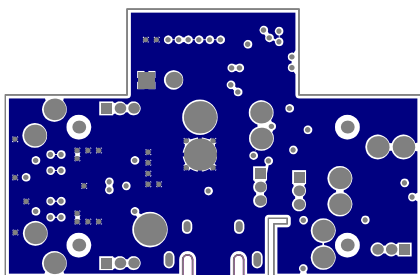
C

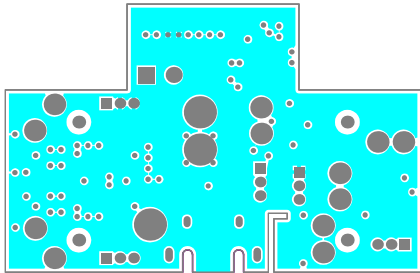
D

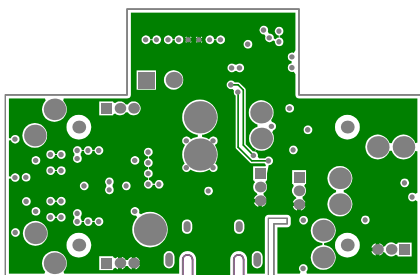


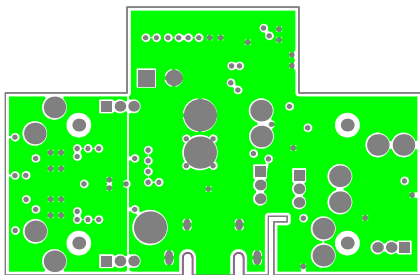
Hello		
TITLE Temperature / Humidity		REV 1
DATE 5/13/2014	DRAWN BY D. Fusi	SHEET 3 OF 3



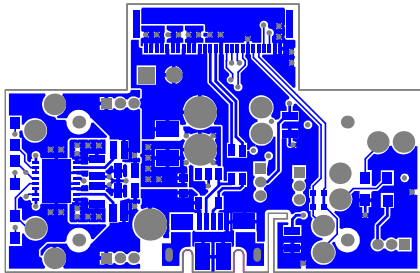


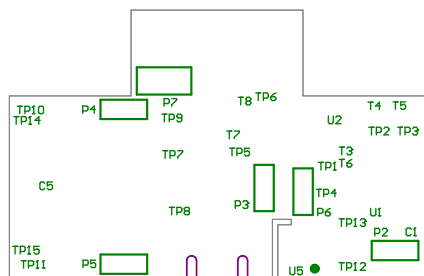


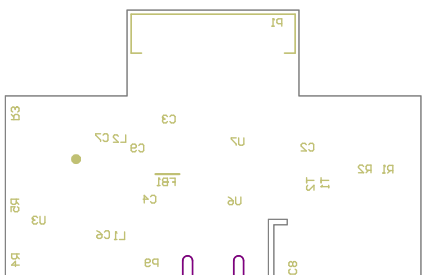


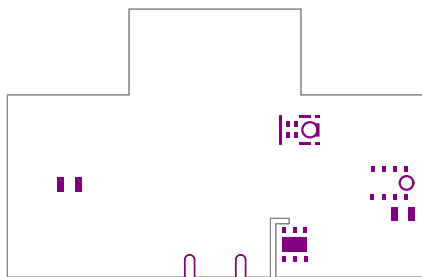


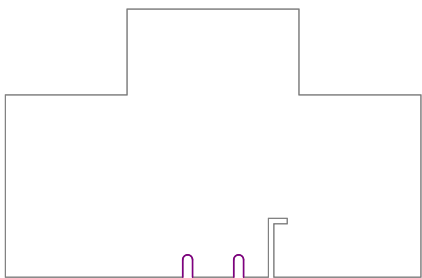


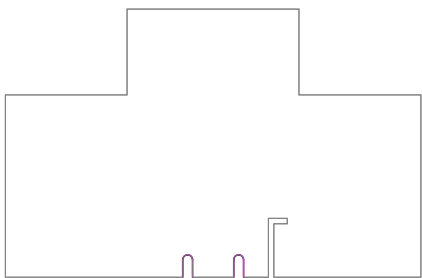


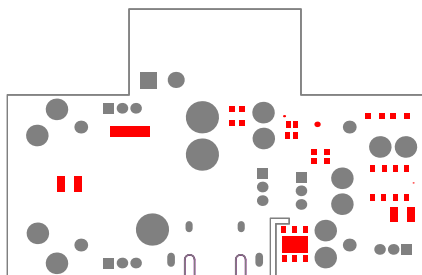


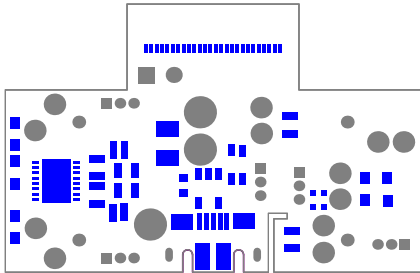




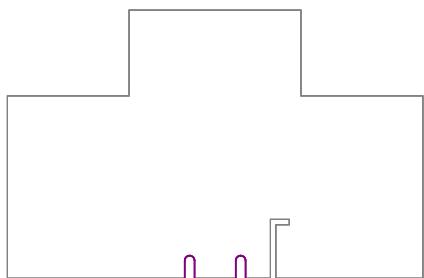












Layer	Name	Material	Thickness	Constant	Board Layer Stack
1	Top Paste				/
2	Top Overlay				
3	Top Solder	Solder Resist	0.010mm	3.5	/
4	Top Layer	Copper	0.036mm		/
5	Dielectric 1	FR-4	0.254mm	4.2	/
6	5V	Copper	0.036mm		/
7	Dielectric 5		0.127mm	4.2	/
8	3.3V	Copper	0.036mm		/
9	Dielectric 4		0.254mm	4.2	/
10	1.8V	Copper	0.036mm		/
11	Dielectric 3		0.127mm	4.2	/
12	GND	Copper	0.036mm		/
13	Dielectric 2		0.254mm	4.2	/
14	Bottom Layer	Copper	0.036mm		/
15	Bottom Solder	Solder Resist	0.010mm	3.5	/
16	Bottom Overlay				/
17	Bottom Paste				/

Symbol	Hit Count	Finished Hole Size	Plated	Hole Type	Physical Length	Rout Path Length
□	2	0.500mm (19.69mil)	PTH	Round	1.050mm (41.34mil)	0.400mm (15.75mil)
✕	2	0.650mm (25.59mil)	PTH	Slot		
⊕	2	0.700mm (27.56mil)	PTH	Slot	1.300mm (51.18mil)	0.600mm (23.62mil)
■	2	0.900mm (35.43mil)	PTH	Round		
☆	3	2.400mm (94.49mil)	PTH	Round		
○	15	0.600mm (23.62mil)	PTH	Round		
●	16	1.700mm (66.93mil)	PTH	Round		
⊗	67	0.200mm (7.87mil)	PTH	Round		
	109 Total					

